



#### N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BV <sub>DSS</sub>	Rds(on)	Ι <sub>D</sub> T <sub>C</sub> = +25°C
950V	2.2Ω@Vgs = 10V	6A

### Description

This new generation complementary dual MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

# Applications

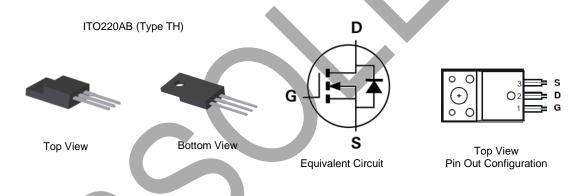
- Motor controls
- Backlighting
- DC-DC converters
- Power management functions

#### Features

- Low Input Capacitance
- High BVDSS Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

## **Mechanical Data**

- Package: ITO220AB
- Package Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Packago		Packing		
Part Nulliber		Package	Qty.	Carrier	
DMN95H2D2HCTI	ITO	220AB (Type TH)	50 Pieces	Tube	

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**





## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	950	V
Gate-Source Voltage			±30	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	ID	6 4	А
Pulsed Drain Current (Note 6)		Iрм	24	A
Avalanche Current, L = 60mH (Note 7)		las	3.5	A
Avalanche Energy, L = 60mH (Note 7)		Eas	360	mJ

# **Thermal Characteristics**

			4		
Characteristic				Max	Unit
Power Dissipation (Note 5)	Tc = +25°C Tc = +100°C	PD		40 14	w
Thermal Resistance, Junction to Case (Note 5)	$T_C = +25^{\circ}C$	R <sub>θJC</sub>		3.6	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Cymser		. , ,	max			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	950			V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS		—	1	μA	V <sub>DS</sub> = 950V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	lgss	_	—	100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						•	
Gate Threshold Voltage	VGS(TH)	3	4	5	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	1.7	2.2	Ω	$V_{GS} = 10V, I_D = 3A$	
Diode Forward Voltage	Vsd	—	0.85	1.2	V	$V_{GS} = 0V$ , $I_S = 6A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss		1487			$V_{DS} = 25V, f = 1MHz,$	
Output Capacitance	Coss		113		pF		
Reverse Transfer Capacitance	Crss	_	1	_		VGS = 0V	
Gate Resistance	Rg	_	4.7		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	20.3				
Gate-Source Charge	Qgs	_	6.4		nC	$V_{DD} = 720V, I_D = 6A,$	
Gate-Drain Charge	Qgd	_	6.1			VGS = 10V	
Turn-On Delay Time	tD(ON)	_	39			V <sub>DD</sub> = 450V, V <sub>GS</sub> = 10V,	
Turn-On Rise Time	t <sub>R</sub>	_	49		ns		
Turn-Off Delay Time	tD(OFF)	_	51		ns	$R_g = 25\Omega, I_D = 6A$	
Turn-Off Fall Time	tF	_	31				
Body Diode Reverse Recovery Time	t <sub>RR</sub>		607		ns	L 64 dl/dt 1004/up	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	8.1	_	μC	l <sub>F</sub> = 6A, dI/dt = 100A/µs	

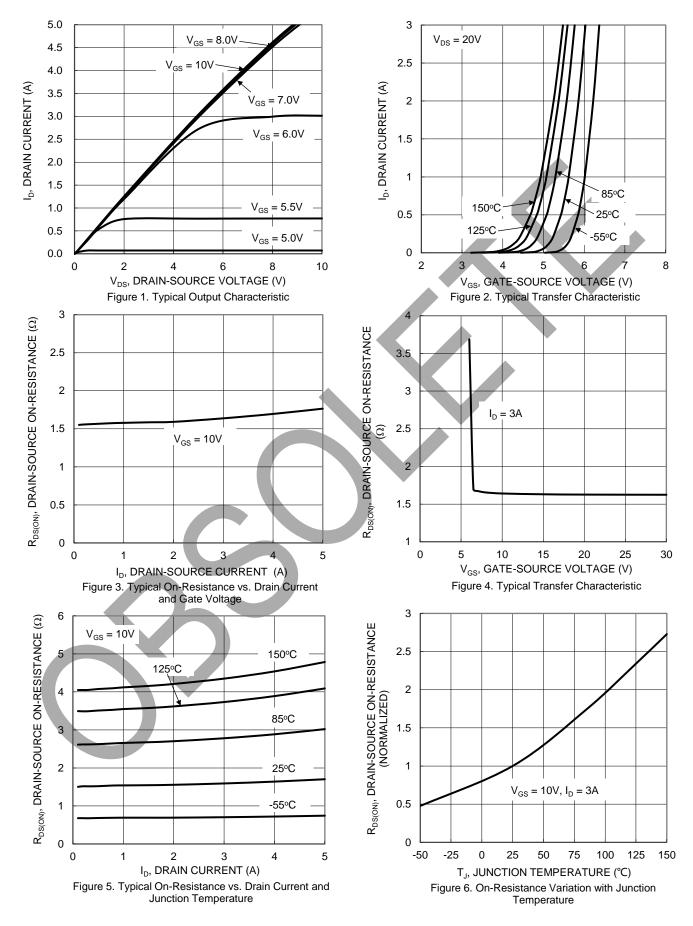
Notes:

Device mounted on infinite heatsink.
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Guaranteed by design. Not subject to production testing.

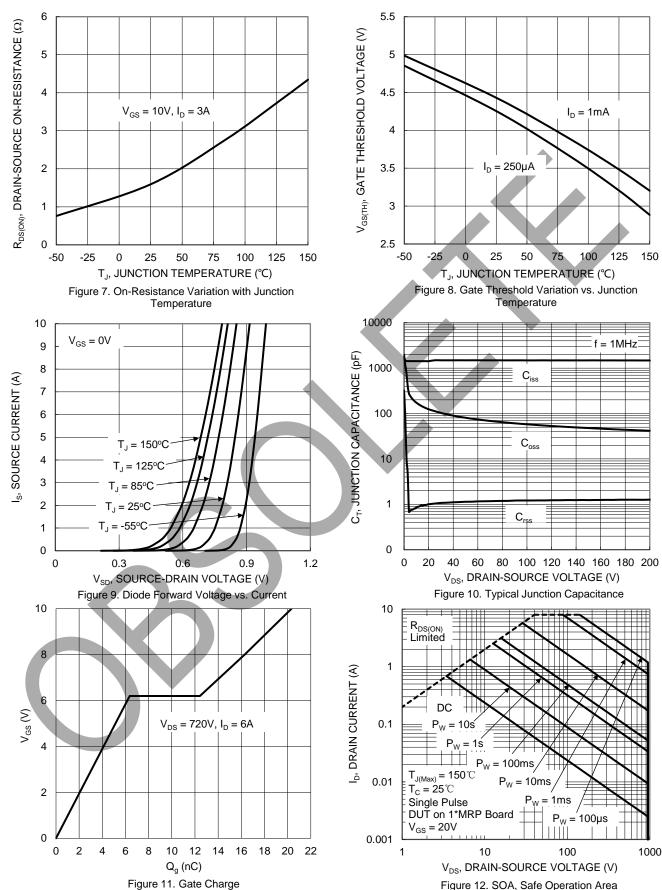
8. Short duration pulse test used to minimize self-heating effect.



## DMN95H2D2HCTI



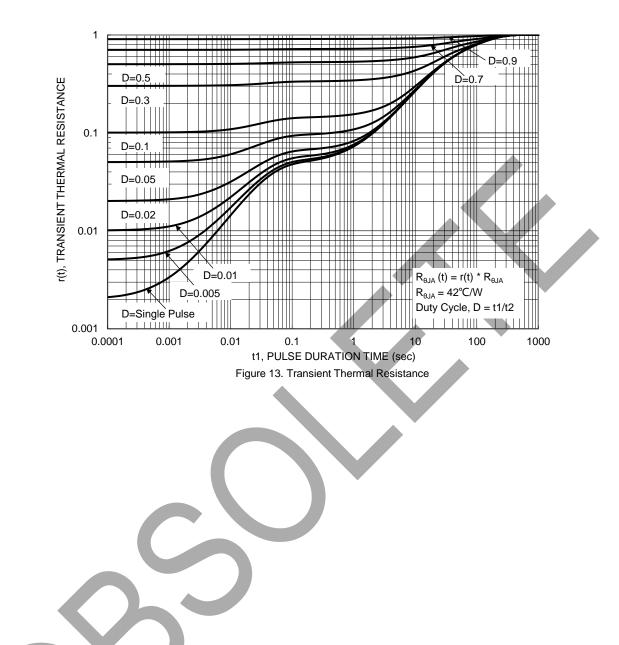




DMN95H2D2HCTI Document number: DS39275 Rev. 4 - 4



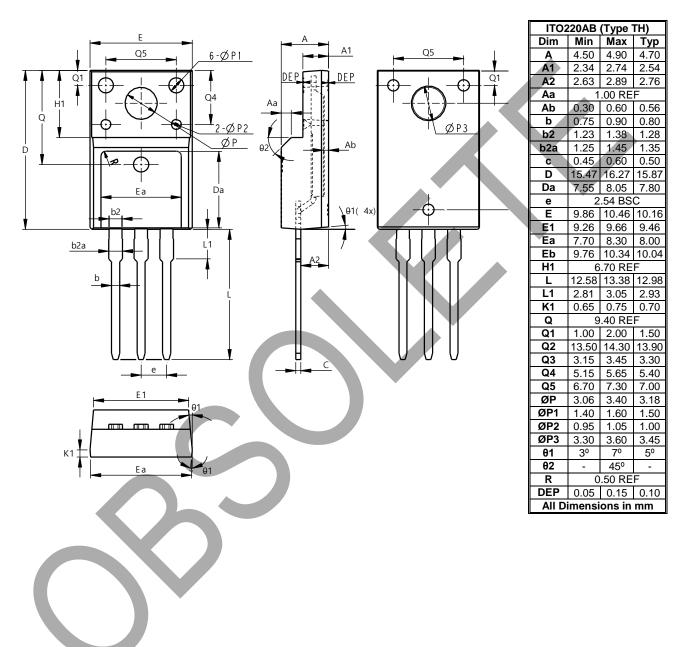






## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



ITO220AB (Type TH)



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